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PATENT

nyo In the united states patent and trademark office

Application of Vladimir Voronkov et al. Serial No. 09/972,608 Filed October 5, 2001 Confirmation No. 4591

Art Unit 2812

For METHOD FOR THE PRODUCTION OF LOW DEFECT DENSITY SILICON

January 9, 2002

TO THE COMMISSIONER OF PATENTS AND TRADEMARKS, SIR:

INFORMATION DISCLOSURE STATEMENT

In accordance with 37 C.F.R. 1.97 and 1.98 and MPEP 609, and in compliance with the duty of disclosure set forth in 37 C.F.R. 1.56, applicants submit copies of the references listed on the attached PTO/SB/08A for consideration by the Patent and Trademark Office in the above-entitled application and to be made of record therein.

The Commissioner is hereby authorized to charge any fees incurred regarding this Information Disclosure Statement to Account No. 19-1345 if an Office Action was issued prior to the date of mailing of this Statement.

Please note that Applicants make no representation as to the accuracy or completeness of the translations submitted herewith.

Respectfully submitted,

Richard A. Schuth, Reg. No. 47,929 SENNIGER, POWERS, LEAVITT & ROEDEL One Metropolitan Square, 16th Floor

St. Louis, Missouri 63102

(314) 231-5400

RAS/msc *Enclosures

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31	I Y I CIMEMA D	TAP	PLICANT	Confirmation Number	4591		
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3	IAIEWENIE	OI AF	PLICANT	Confirmation Number	4591	
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